

Electron Microscopy Imaging of Highly Sensitive Crystalline Chemical Materials

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This presentation will focus on our recent works pertaining to the high-resolution imaging of electron beam-sensitive materials using ultralow electron doses. The following technological advances will be discussed. First, the development of a suite of methods to address the challenges peculiar to low-dose TEM imaging, including rapid search for crystal zone axes, precise alignment of the image stack, and accurate determination of the defocus value, enables efficient imaging of electron beam-sensitive crystalline materials in the high-resolution TEM (HRTEM) mode [1-3]. Second, integrated differential phase contrast STEM (iDPC-STEM) has proven to be an effective method for acquiring directly interpretable atomic-resolution images under low-dose conditions [4]. Third, I will share my views on the great potential of four-dimensional STEM (4D-STEM) electron ptychography in imaging highly electron beam-sensitive materials and provide preliminary results to demonstrate its feasibility [5-6].

References:

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- [2] Atomic-resolution transmission electron microscopy of electron beam-sensitive crystalline materials. *Science* 2018, 359, 675-679.
- [3] Imaging defects and their evolution in a metal-organic framework at sub-unit-cell resolution. *Nat. Chem.* 2019, 11, 622-628.
- [4] Direct Imaging of Atomically Dispersed Molybdenum that Enables Location of Aluminum in the Framework of Zeolite ZSM-5, *Angew. Chem. Int. Ed.*, 2020, 59, 819-825
- [5] Three-dimensional inhomogeneity of zeolite structure and composition revealed by electron ptychography. *Science* 2023, 380, 633-638.
- [6] Atomically resolved imaging of radiation-sensitive metal-organic frameworks via electron ptychography. *Nat. Commun.* 2025, 16, 914.